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Role of the Gate in Ballistic Nanowire SOI MOSFETs

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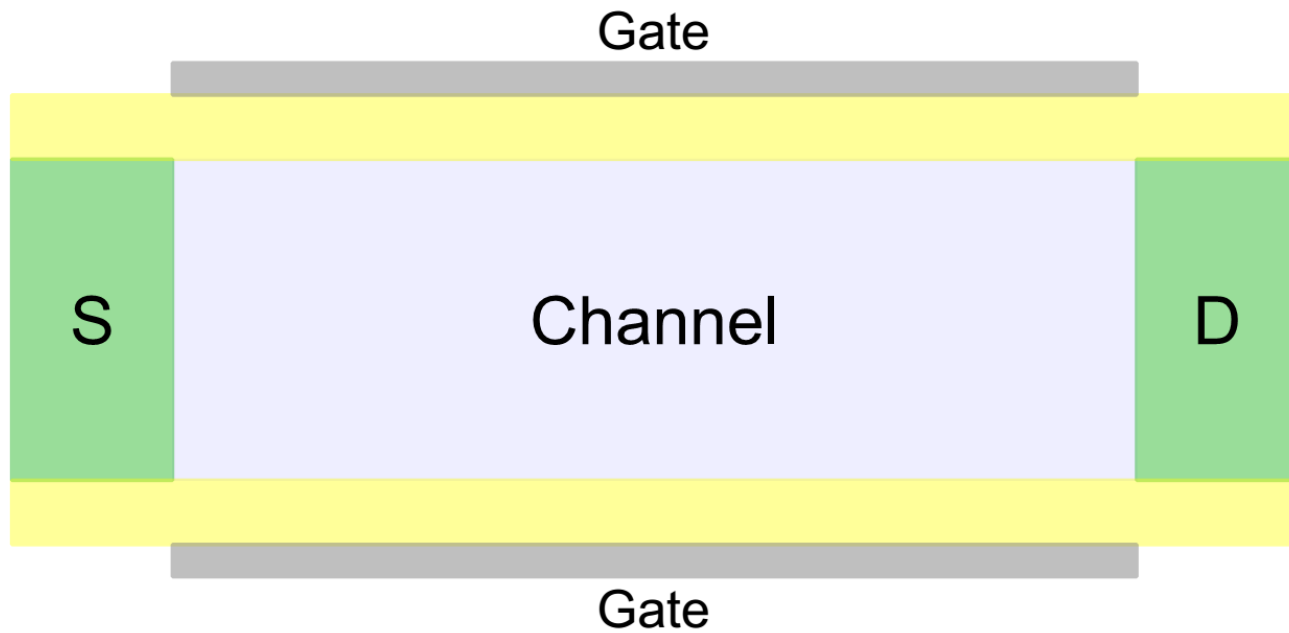
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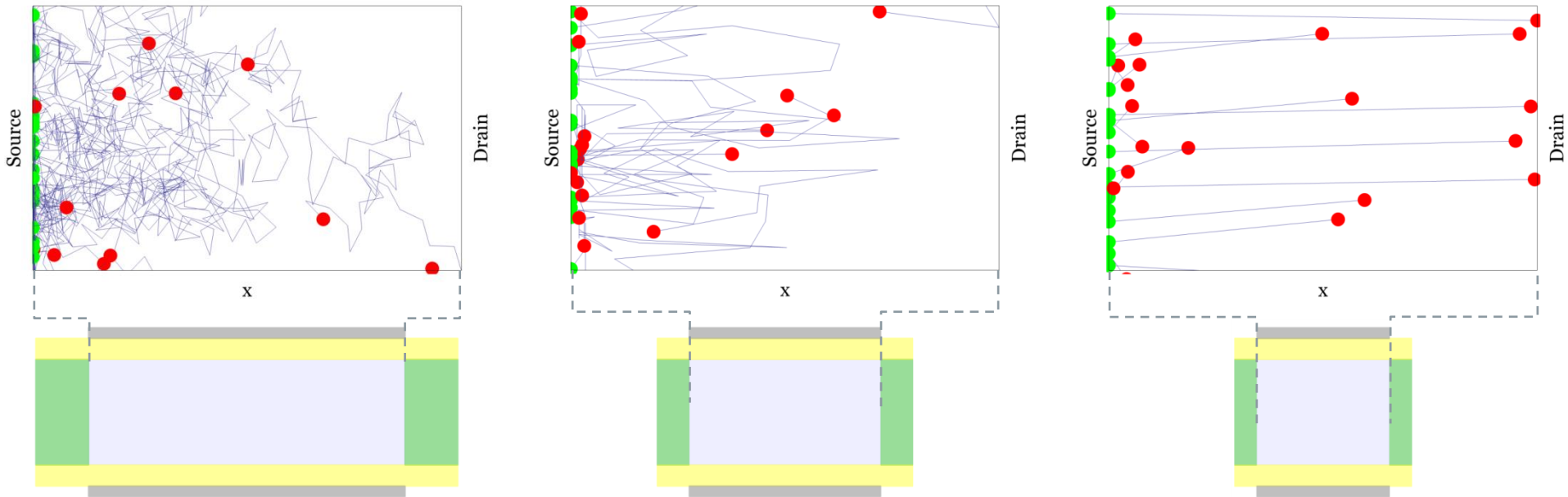
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Double-Gate Nanowire SOI MOSFET



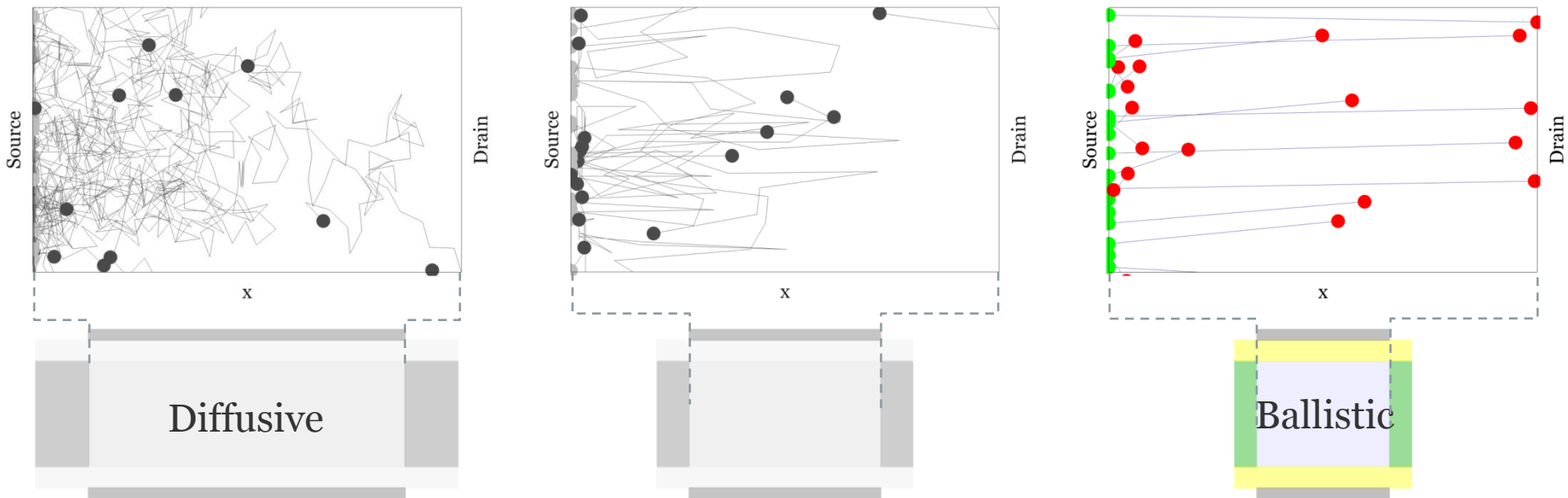
The picture inside the MOSFET

- A simplistic view of charge transport inside the MOSFET channel:



The picture inside the MOSFET

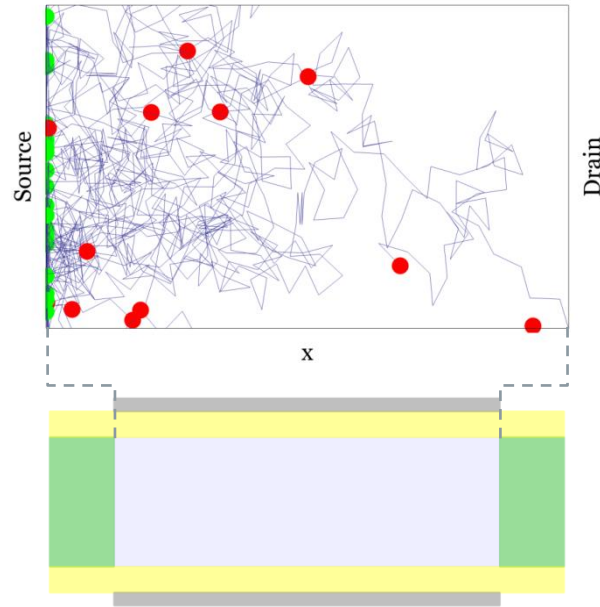
- A simplistic view of charge transport inside the MOSFET channel:



- Electrons travel across the channel **without scattering** in a ballistic MOSFET

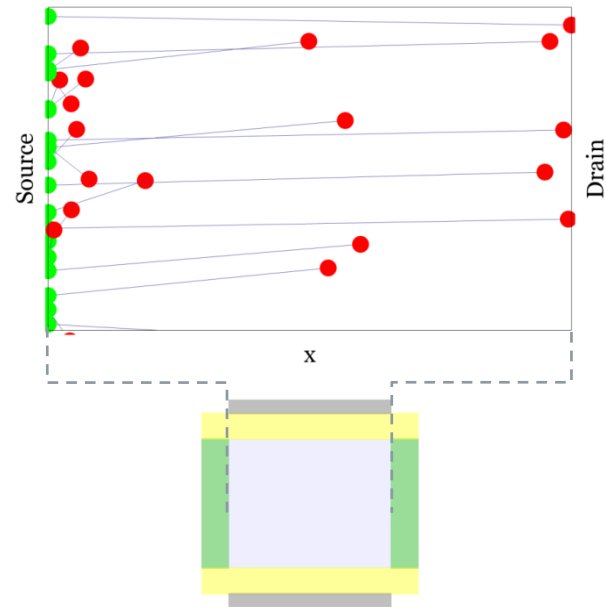
What role does the gate play?

- Diffusive:



- ▶ Carrier population depends on **local channel potential** which is **function of gate voltage**

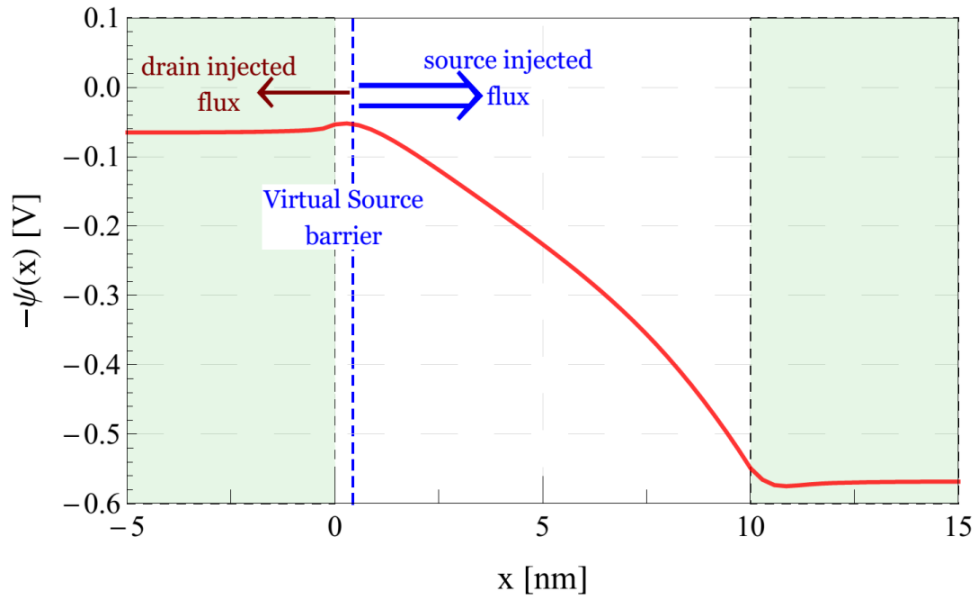
- Ballistic:



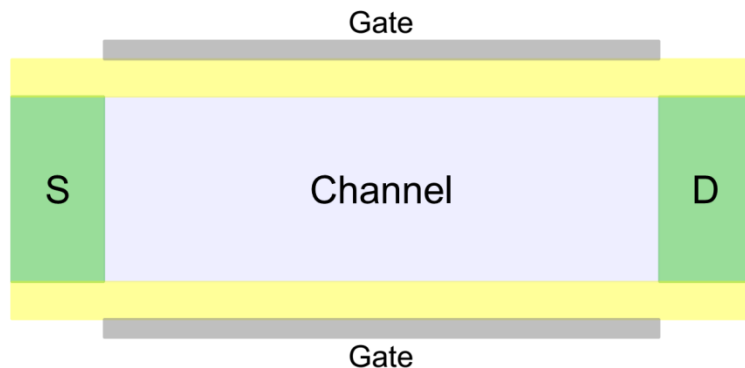
- ▶ Carrier population is governed by **source and drain Fermi levels** and **NOT the local quasi-Fermi level**

Ballistic MOSFET \equiv vacuum tube?

- The barrier model [Lundstrom]:

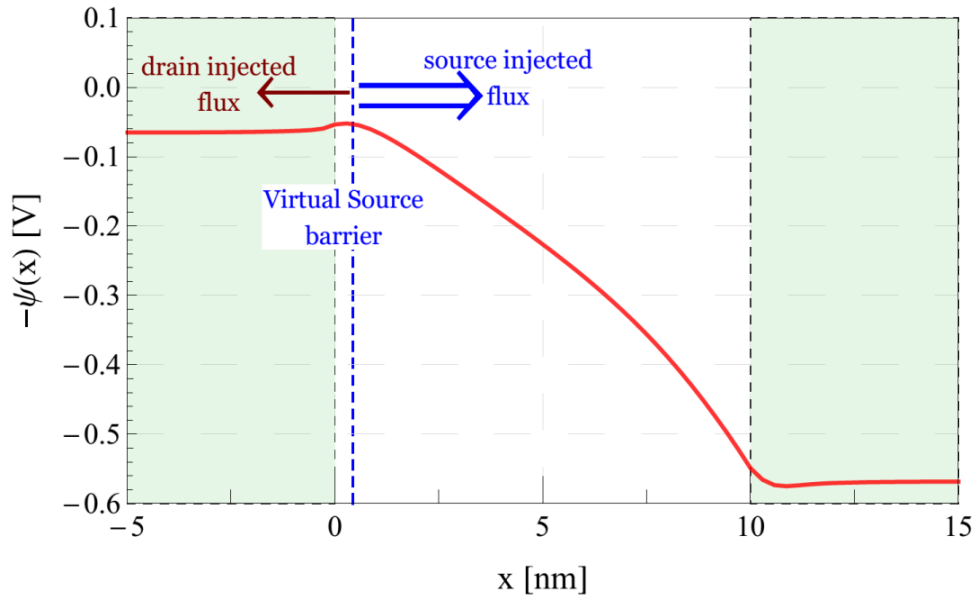


- Virtual Source barrier: potential bump which acts as the effective source of carriers
- The gate voltage V_G controls its height

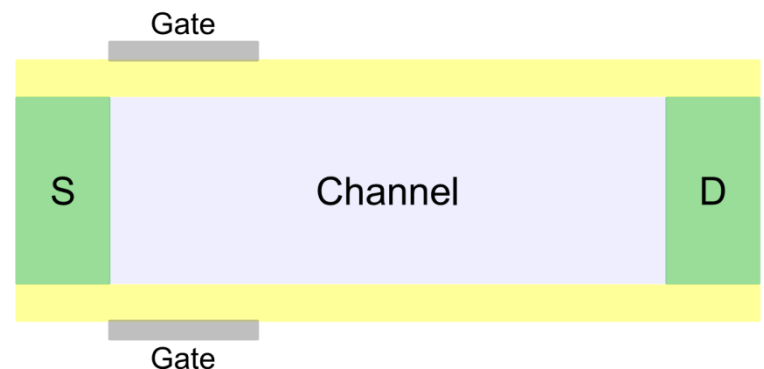
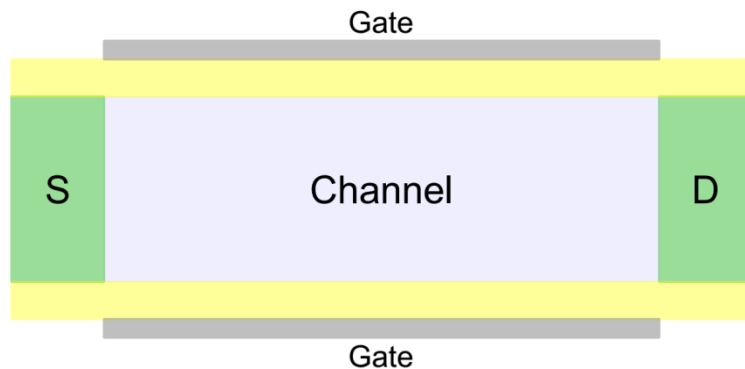


Ballistic MOSFET \equiv vacuum tube?

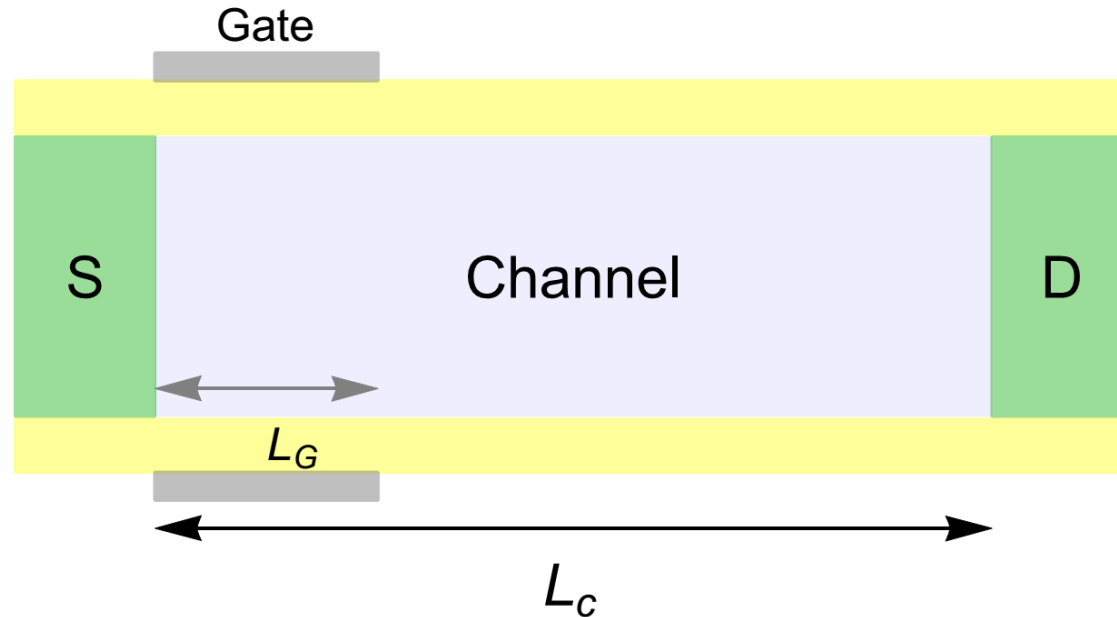
- The barrier model [Lundstrom]:



- **Virtual Source barrier:** potential bump which acts as the effective source of carriers
- The gate voltage V_G controls its height



A ballistic MOSFET with *partial gates*

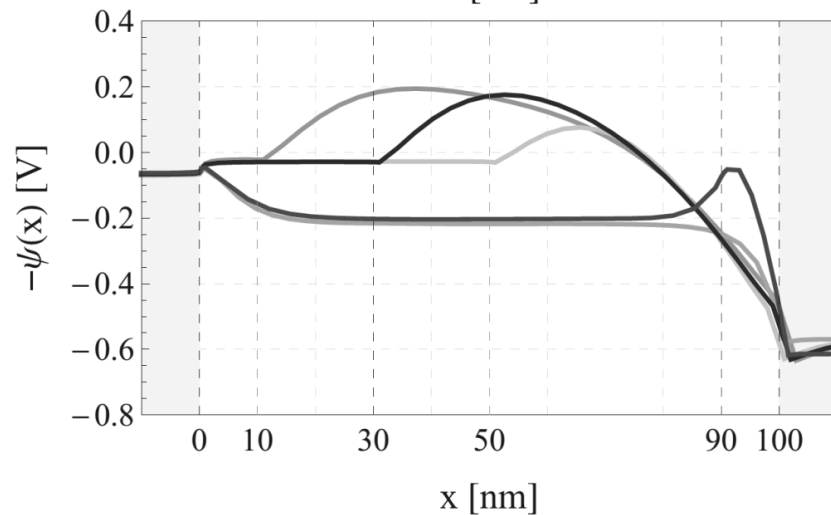
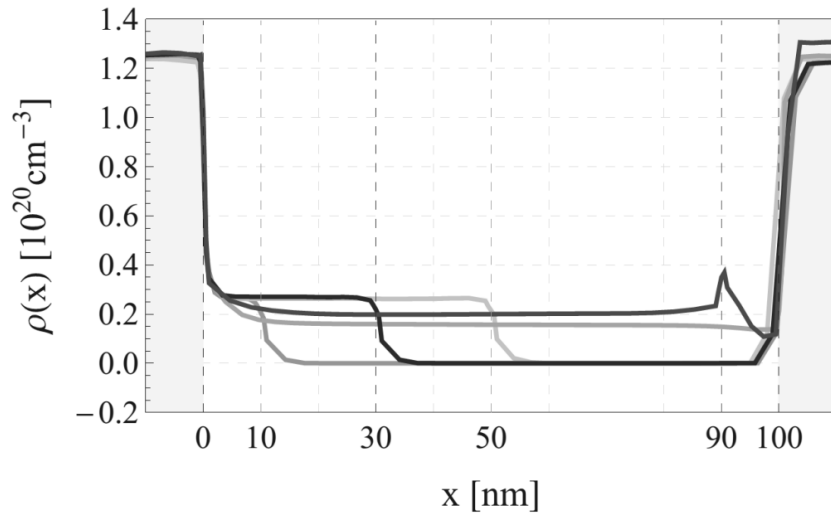


- L_c : Length of the channel between the source and drain junctions
- L_G : Length of the channel covered by the metal gate

Effect of gate length | Short channel ($L_C = 10$ nm)

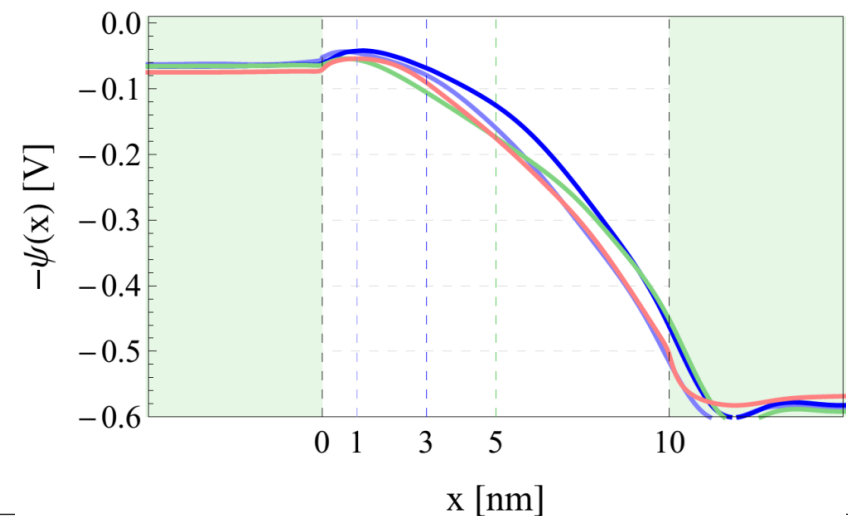
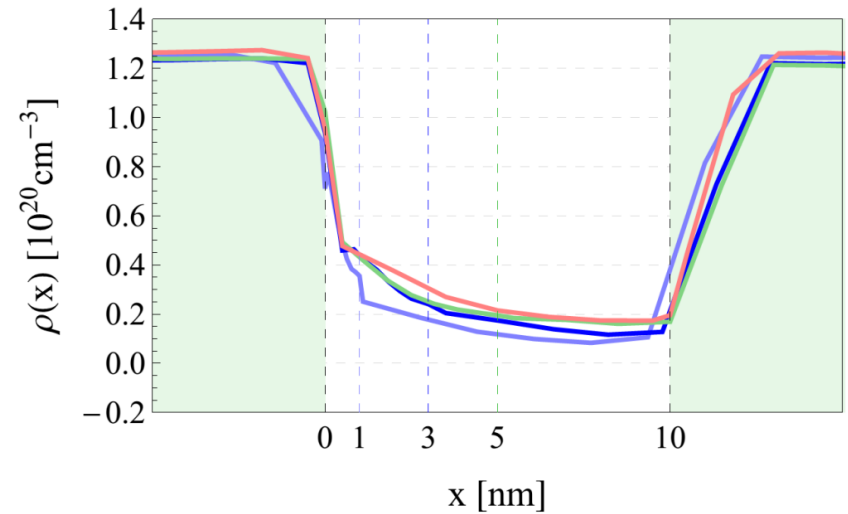
■ $L_C = 100$ nm

L_G/L_C : — 0.1 — 0.3 — 0.5 — 0.9 — 1



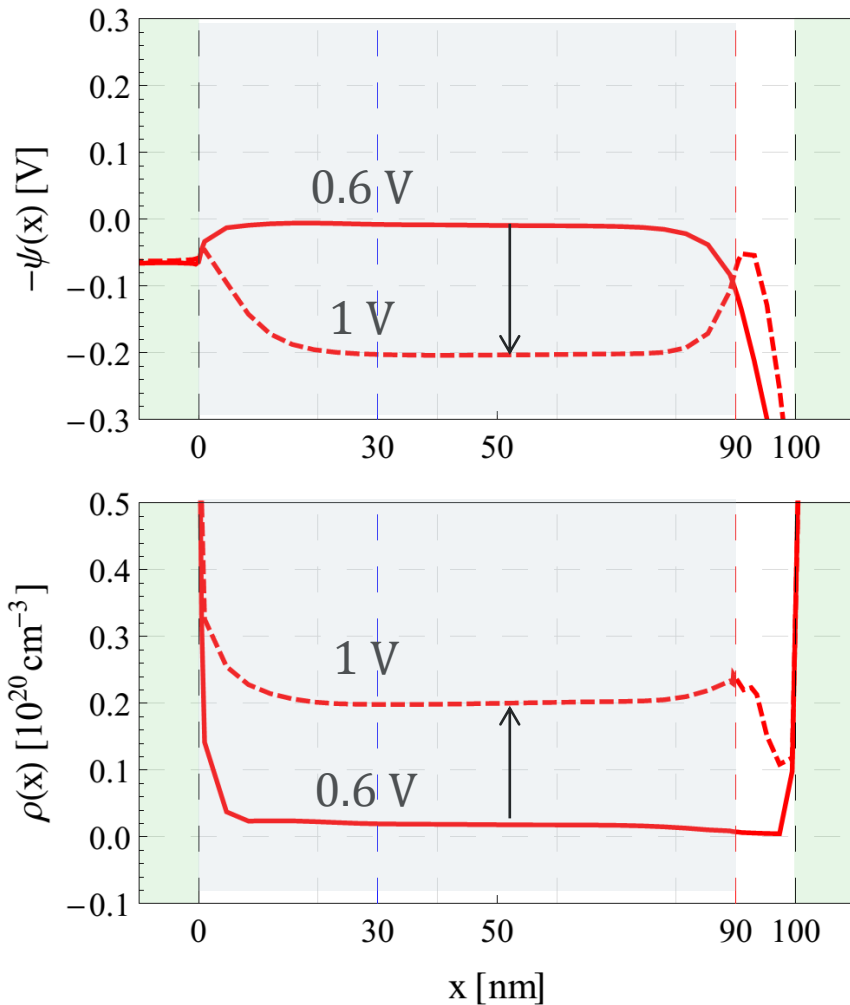
■ $L_C = 10$ nm

L_G/L_C : — 0.1 — 0.3 — 0.5 — 1

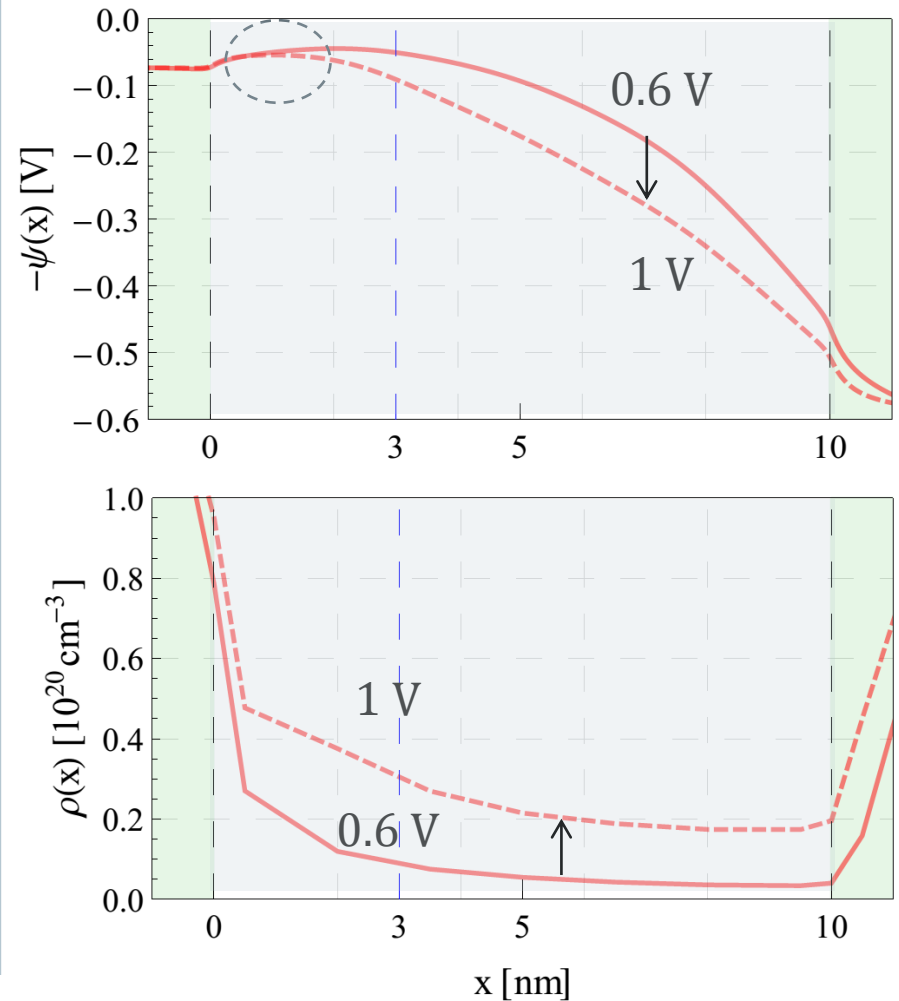


Effect of gate voltage | Long gate

- Channel length $L_c = 100$ nm

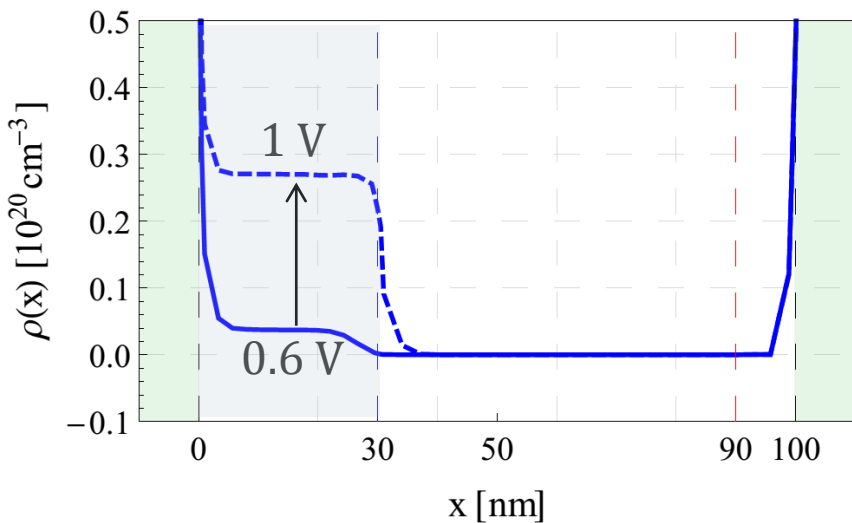
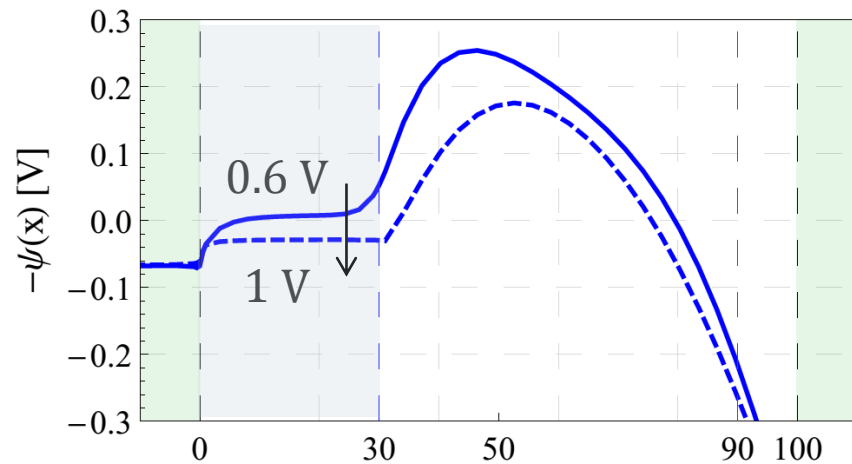


- Channel length $L_c = 10$ nm

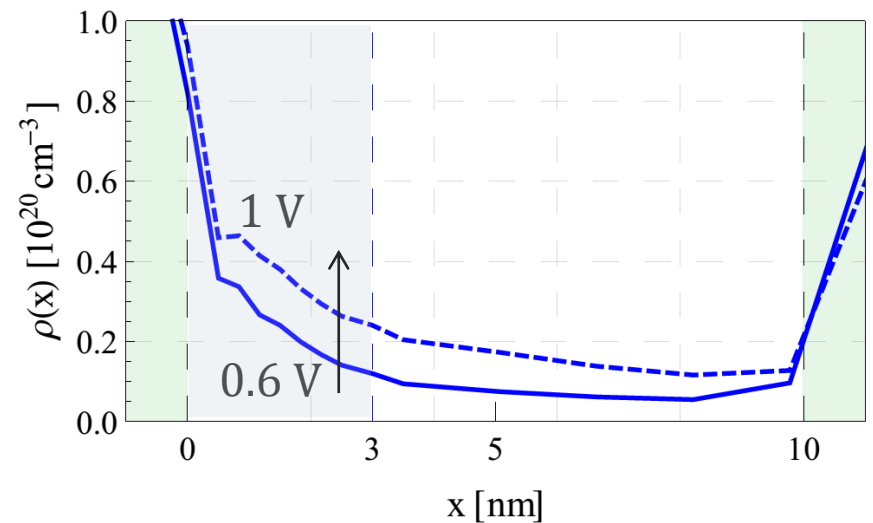
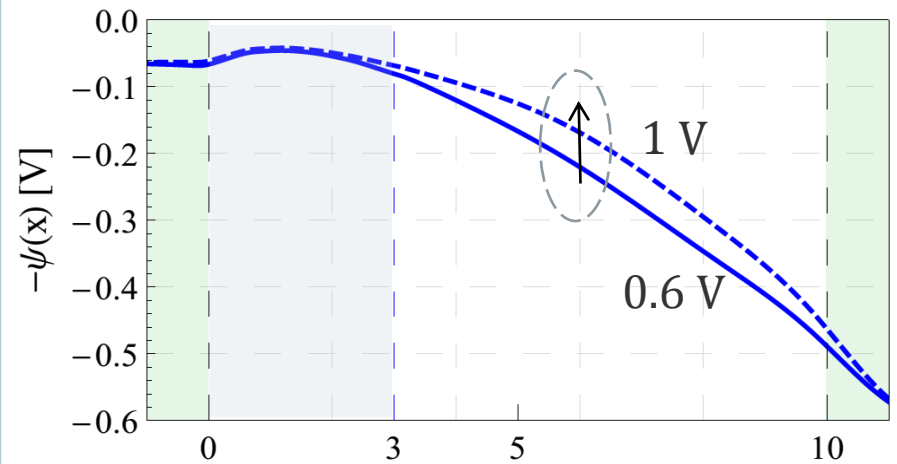


Effect of gate voltage | Short gate ($L_G/L_C = 0.3$)

- Channel length $L_C = 100$ nm

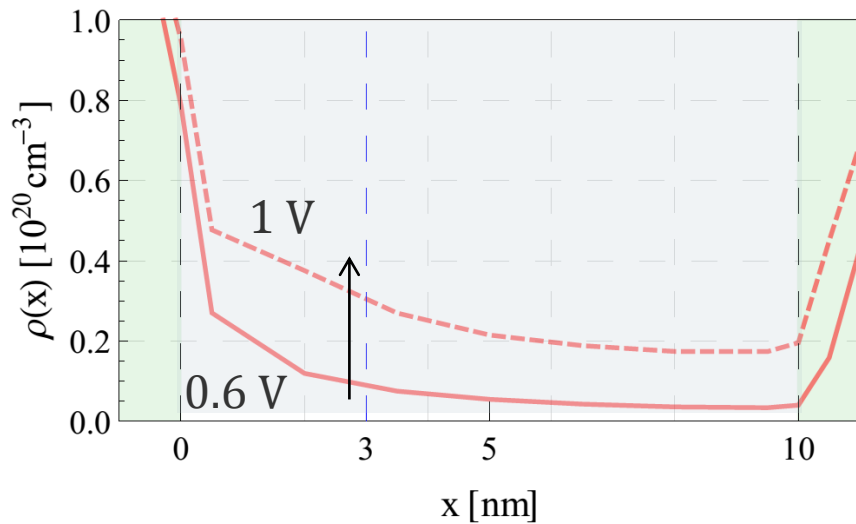
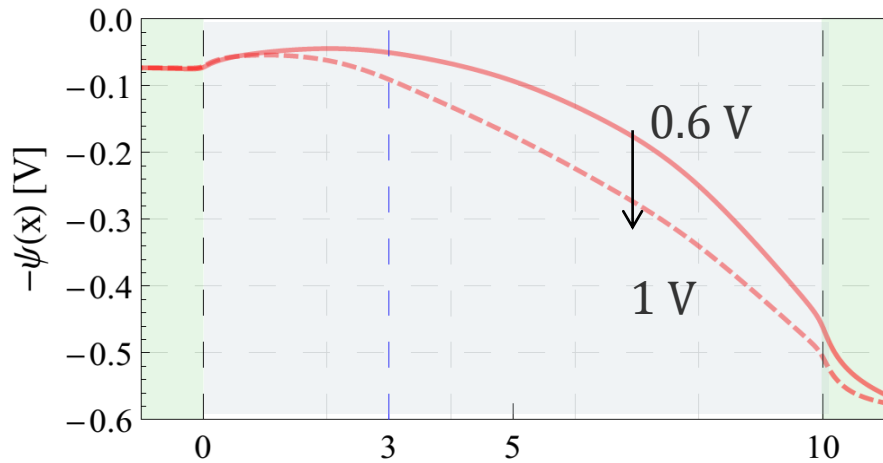


- Channel length $L_C = 10$ nm

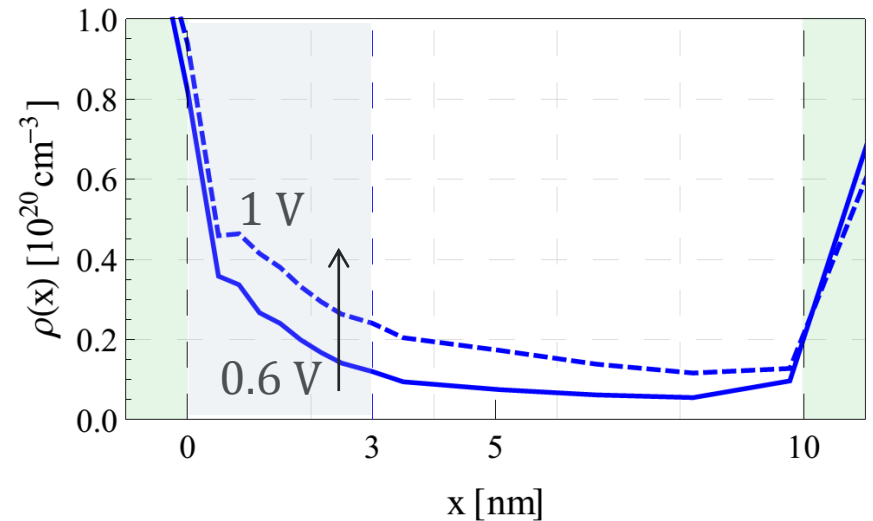
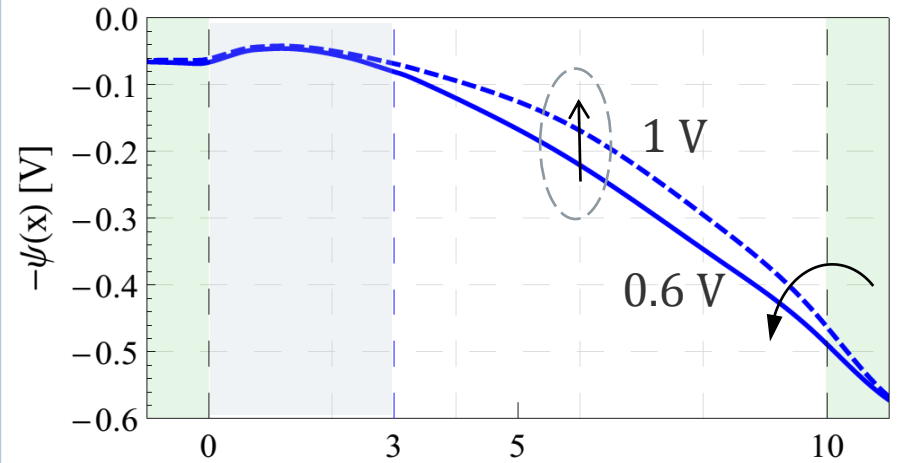


Effect of gate voltage | Channel length $L_c = 10$ nm

Long gate



Short gate



Effect of gate Voltage | Channel length $L_c = 10$ nm

- Poisson's equation:

$$\frac{\partial^2 \psi(x,y)}{\partial x^2} + \underbrace{\frac{\partial^2 \psi(x,y)}{\partial y^2}}_{\text{Gate}} = \frac{q\rho(x,y)}{\epsilon_{\text{Si}}}$$

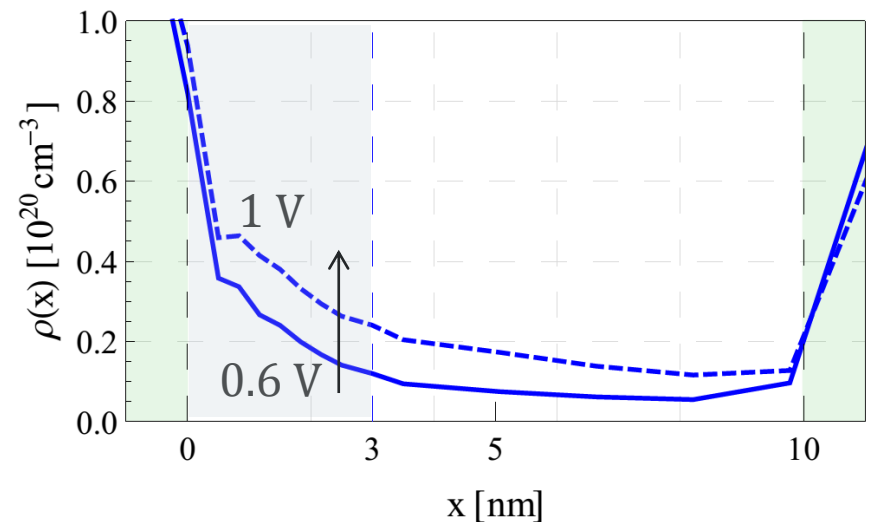
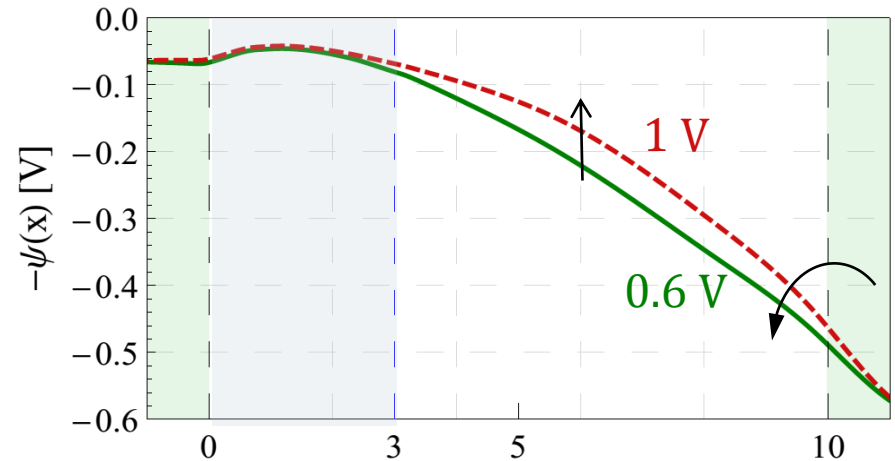
- In the **non-gated part**:

$$\frac{\partial^2 \psi(x,y)}{\partial x^2} = \frac{q\rho(x,y)}{\epsilon_{\text{Si}}}$$

$$\psi(x) = \underbrace{\frac{q\rho}{2\epsilon_{\text{Si}}}}_{\text{charge}} x^2 + \underbrace{c_1 x + c_2}_{V_D}$$

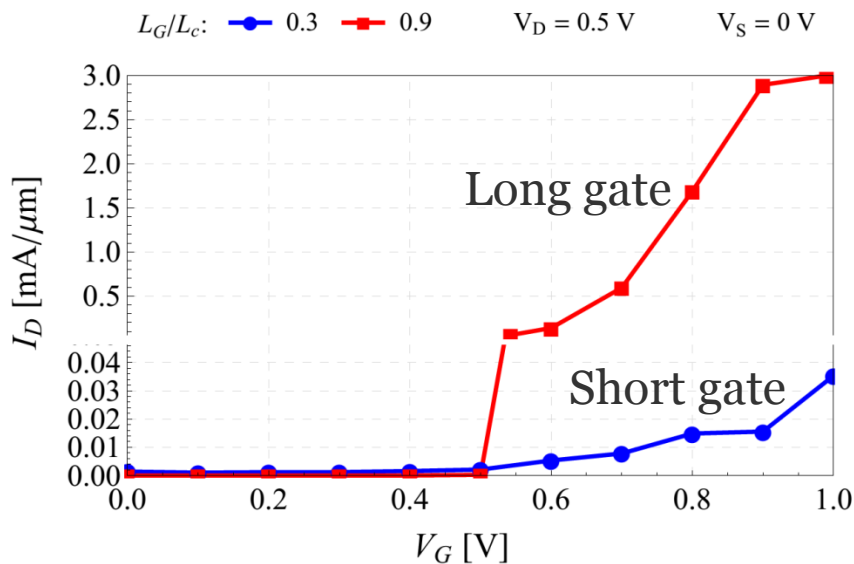
- Channel electrostatics **dominated by drain**, especially at low V_G

- Short gate



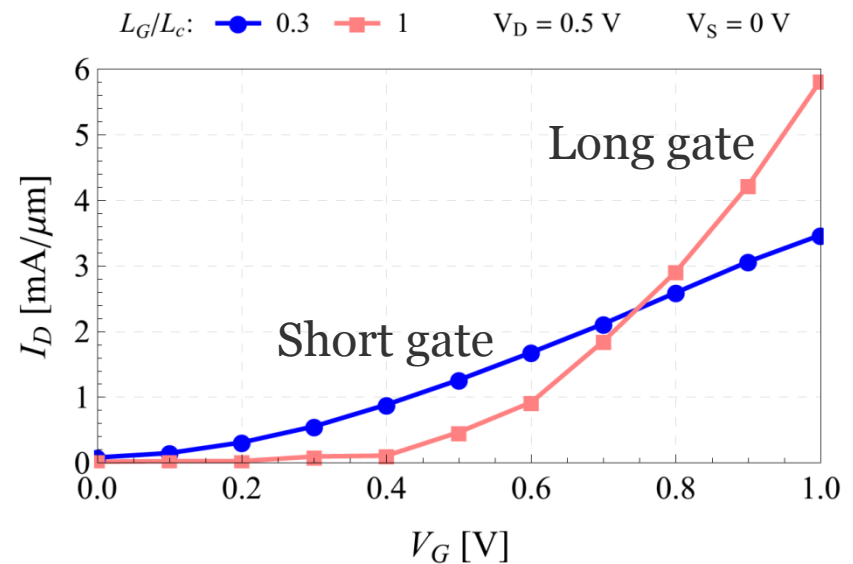
Ballistic drain current

- Channel length $L_c = 100$ nm



- Short gate current **two orders of magnitude less** than the long gate current

- Channel length $L_c = 10$ nm

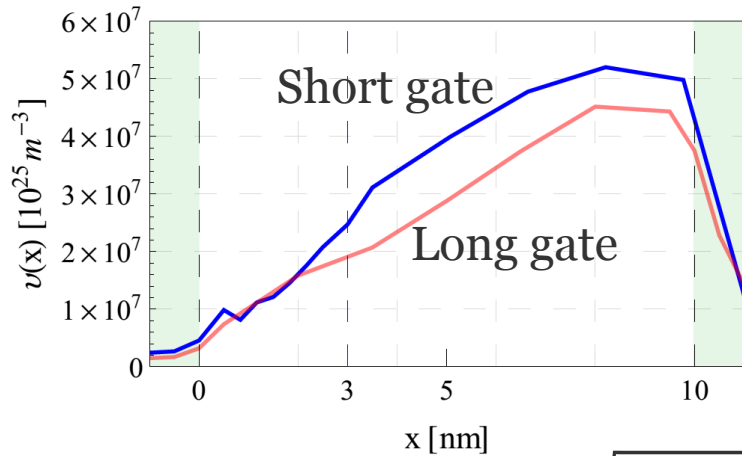


- Same order of magnitude in the short and long gate cases
- Short gate current > long gate current at low voltages!**

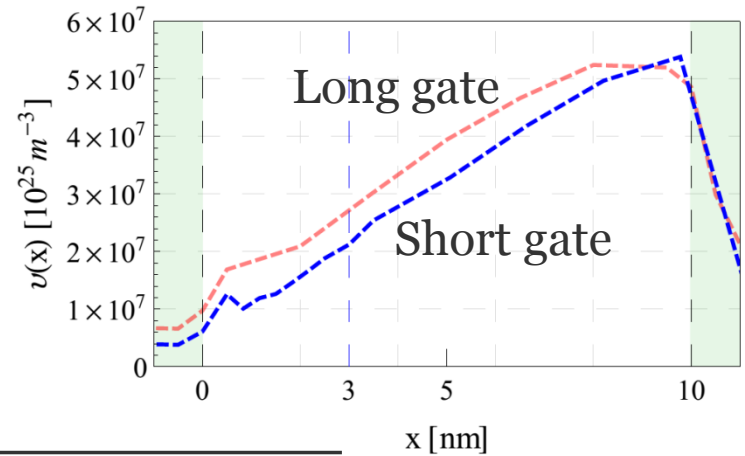
$$I_D = q\rho(x)v(x)$$

Ballistic carrier velocity | Channel length $L_c = 10$ nm

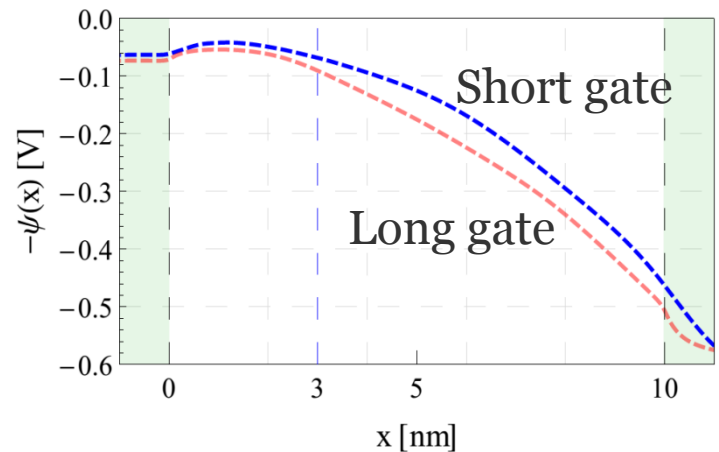
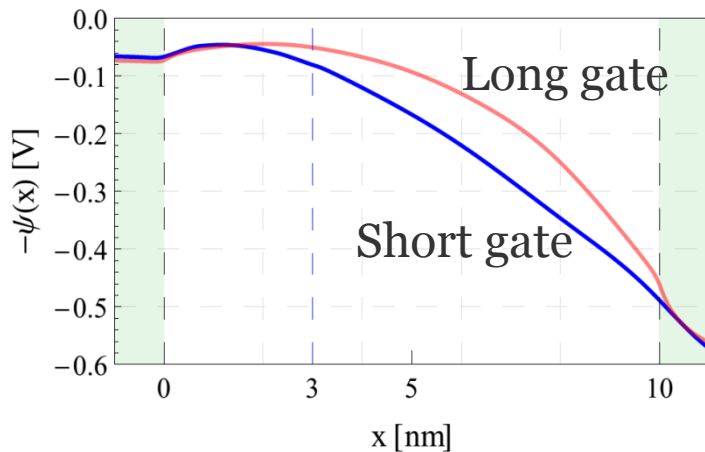
- $V_G = 0.6$ V $v(x)_{\text{short}} > v(x)_{\text{long}}$



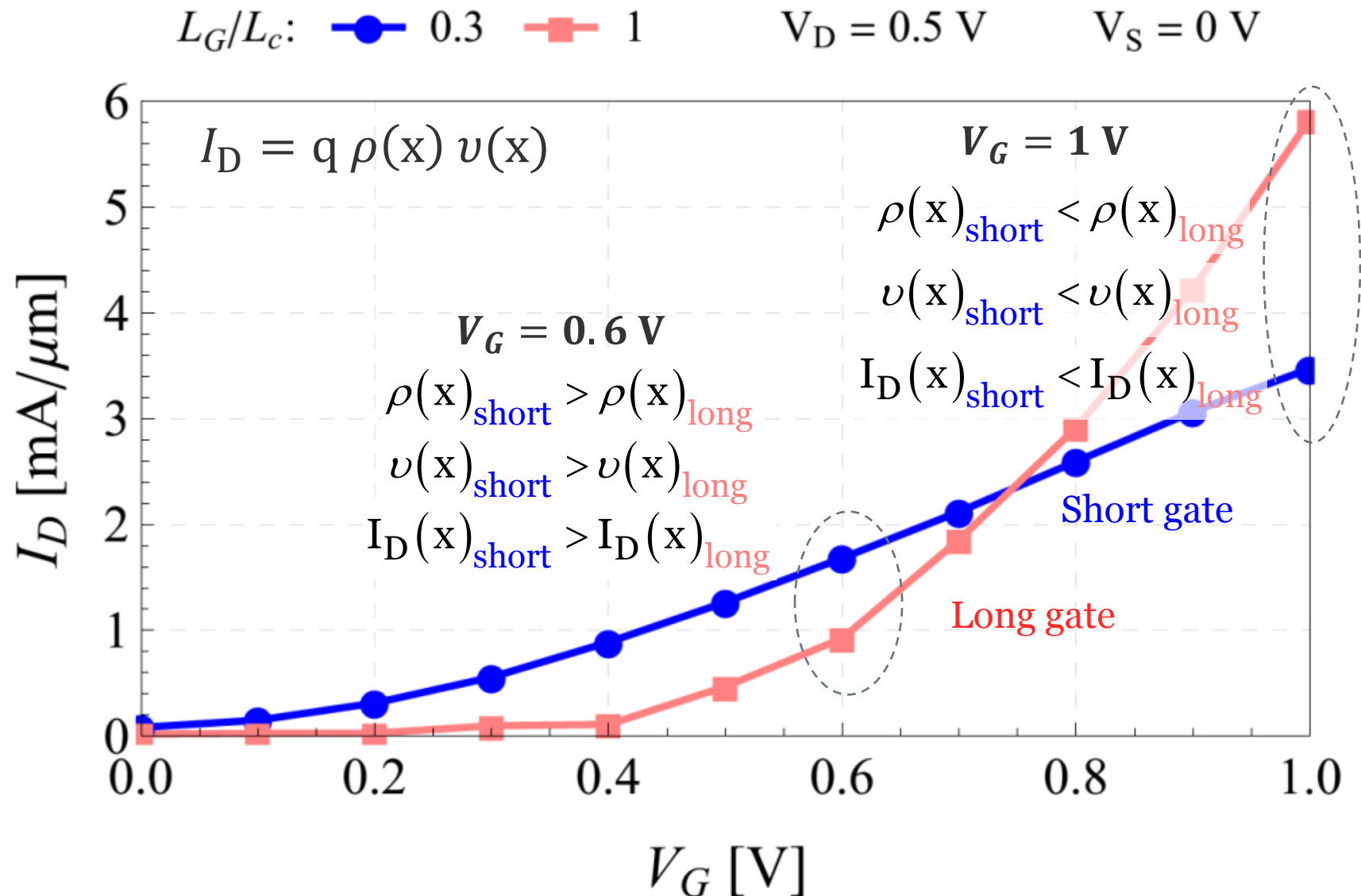
- $V_G = 1$ V $v(x)_{\text{short}} < v(x)_{\text{long}}$



$$v(\mathbf{x}) = \sqrt{-\frac{2q}{m}(\psi(\mathbf{x}) - \psi_{\text{vs}}(\mathbf{x})) + v_{\text{vs}}(\mathbf{x})}$$

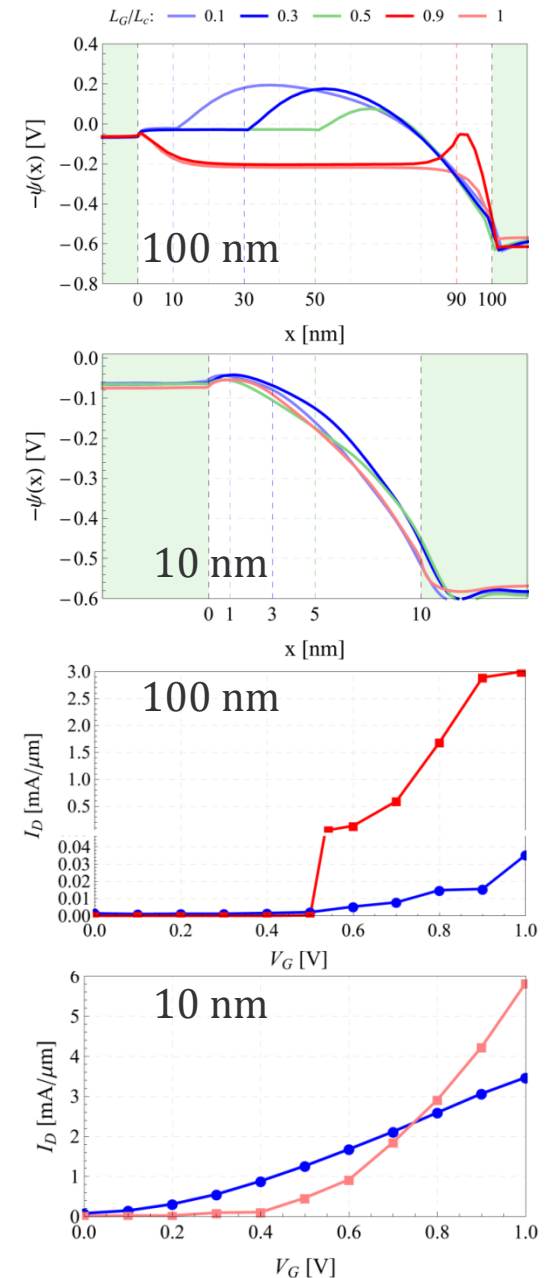


Ballistic drain current | Channel length $L_c = 10$ nm



Conclusions

- What role does the gate play?
 - ▶ 100 nm: The gate controls the electrostatics.
 - ▶ 10 nm: The drain dominates the electrostatics.
- Is a partial gate sufficient?
 - ▶ 100 nm: No, the drain current is diminished.
 - ▶ 10 nm: Same order of magnitude of drain current in the partial and full gate cases.
- Full gate is necessary to maintain current efficiency even in 10 nm ballistic devices.
- Drain current in ballistic devices is NOT independent of channel length.
- Perspectives: development of ballistic compact model including channel electrostatics.



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Questions?

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